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**Declaration and Power of Attorney  
Under Patent Cooperation Treaty  
35 USC §371(c)(4)**

As a below named inventor, I hereby declare that:

my residence, post office address and citizenship are as stated below next to my name; that

I verily believe that I am the original, first and sole inventor (if only one name is listed below) or a joint inventor (if plural names are named below) of the invention entitled: Non-Cu-Based Cast Al Alloy and Method for Heat Treatment Thereof described and claimed in the international application number PCT/JP00/05600 filed August 22, 2000 and as amended on \_\_\_\_\_ (if any), the specification and claims of which I have reviewed and understand and for which I solicit a patent.

I acknowledge my duty to disclose information of which I am aware which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a), and that no application for patent or inventor's certificate on this invention has been filed in any country foreign to the United States of America prior to my international application by me or my legal representatives or assigns, except as follows:

Japanese patent application No.11-246813 filed on August 31, 1999,  
Japanese patent application No.2000-056560 filed on March 1, 2000, and  
Japanese patent application No.2000-131414 filed on April 28, 2000.

The priority of the above applications (if any), filed within a year prior to my international application is hereby claimed under 35 USC 119. I hereby appoint the following as my attorneys of record with full power of substitution and revocation to prosecute this application and to transact all business in the patent office:

Roger W. Parkhurst, Reg. No. 25,177; Charles A. Wendel, Reg. No. 24,453; Lawrence D. Eisen, Reg. No. 41,009.

**ALL CORRESPONDENCE IN CONNECTION WITH THIS APPLICATION SHOULD BE SENT TO:  
PARKHURST & WENDEL, L.L.P., 1421 PRINCE STREET, SUITE 210, ALEXANDRIA, VIRGINIA 22314-2805, TELEPHONE (703) 739-0220.**

I hereby declare that I have reviewed and understand the contents of this Declaration, and that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with knowledge that willful false statements and the like so made are punishable by fine or imprisonment or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

3. Full Name of Sole or First Inventor	<u>Takayuki</u>		SAKAI
	Given Name	Middle Initial	Family Name
*4. Inventor's Signature	<u>Takayuki Saka</u>		
Date of Signature	February	14th	2002
6. Residence	Month	Day	Year
	<u>Kikugawa-cho</u>	<u>Shizuoka-prefecture</u>	<u>Japan</u>
City	State or Province	Country	
7. Citizenship	<u>Japanese</u>		
8. Post Office address (Insert complete mailing address, including country)	<u>c/o Asahi Tec Corporation, 547-1, Horinouchi, Kikugawa-cho, Ogasa-gun, Shizuoka-prefecture, 439-8651 Japan</u>		

\*IF THERE IS MORE THAN ONE INVENTOR USE PAGE 2 AND PLACE AN "X" HERE